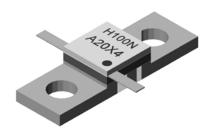




### Model H100NA20X4

# Flange Attenuator 100 Watts, 20 dB

## RF Power



#### Features:

- RoHS Compliant
- 100 Watts
- DC 2.7 GHz
- AIN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested
- Small Size

#### **Description**

The H100NA20X4 is high performance Aluminum Nitride (AIN) high power flange mount attenuator intended as a cost competitive alternative to Beryllium Oxide (BeO). The termination is well suited to all cellular frequency bands such as; AMPS, GSM, DCS, PCS, PHS and UMTS. The high power handling makes the part ideal for terminating circulators, and for use in power monitoring. The termination is also RoHS compliant!

#### **General Specifications**

Resistive Element
Substrate
Cover
Alumina Ceramic
Mounting Flange
Nickel Plated Copper

**Operating Temperature** -55 to +150°C (see de rating chart) Tolerance is ±0.010", unless otherwise specified. Designed to meet of exceed

Tolerance is  $\pm 0.010$ ", unless otherwise specified. Designed to meet of excee applicable portions of MIL-E-5400. **All dimensions in inches.** 

#### **Electrical Specifications**

**Attenuation Value:** 20 dB,  $\pm$  1.0 dB, DC – 4.0GHz

Power: 100 Watts

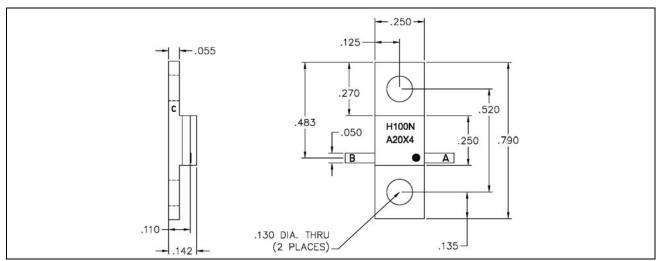
Frequency Range: DC - 4.0 GHz

Return Loss > 24 dB to 2.7 GHz

> 20 dB to 4.0 GHz

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.** 

#### **Outline Drawing**



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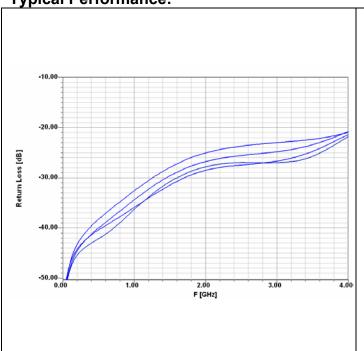
USA/Canada: Toll Free: Europe: (315) 432-8909 (800) 544-2414

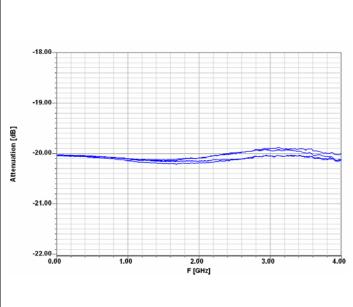
+44 2392-232392





**Typical Performance:** 

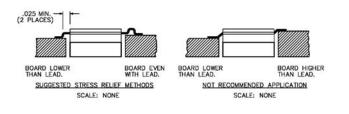




#### **Power De-rating:**

#### POWER DERATING POWER 100 75 RATED 50 -25 Ы 0 % 25 50 75 100 125 150 SOLDER INTERFACE TEMPERATURE - "C

#### **Mounting Footprint and Procedure:**



#### SUGGESTED MOUNTING PROCEDURES:

- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
- COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
- 4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
- SOLDER LEADS IN PLACE USING LEAD FREE TYPE SOLDER WITH A CONTROLLED TEMPERATURE IRON

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